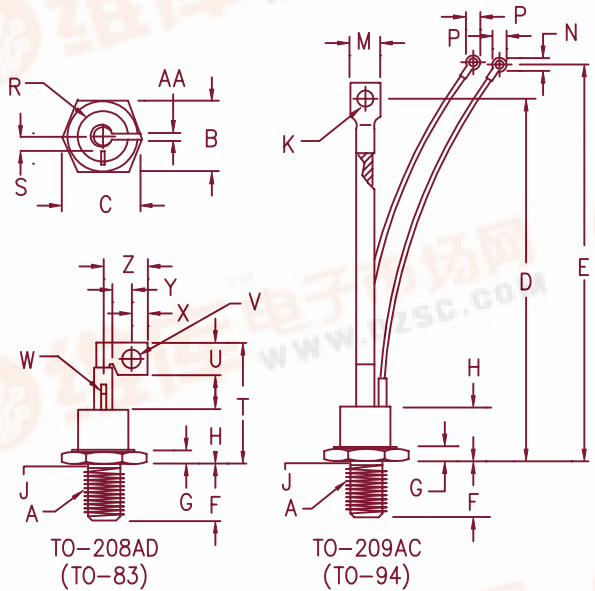


# Silicon Controlled Rectifier Series 080



Note 1: 1/2-20 UNF-3A  
 Note 2: Full thread within 2 1/2 threads  
 Note 3: To specify package designation other than standard lead enter appropriate letter in place of "A".  
 "B" = Insulated lead  
 "D" = Flag Terminal  
 "C" = Top Stud (consult factory)

Dim.	Inches		Millimeter		Notes
	Minimum	Maximum	Minimum	Maximum	
A	---	---	---	---	1
B	1.050	1.060	26.67	26.92	
C	---	1.161	---	29.49	
D	5.850	6.144	149.10	156.06	
E	6.850	7.375	173.99	187.33	
F	.797	.827	20.24	21.01	
G	.276	.286	.701	7.26	
H	---	.948	---	24.08	
J	.425	.499	10.80	12.67	2
K	.260	.280	6.60	7.11	Dia.
M	.500	.600	12.70	15.24	
N	.140	.150	3.56	3.81	
P	---	.295	---	7.49	
R	---	.900	---	22.86	Dia.
S	.225	.275	6.48	6.99	
T	---	1.750	---	44.45	
U	.370	.380	9.40	9.65	
V	.213	.223	5.41	5.66	Dia.
W	.065	.075	1.65	1.91	Dia.
X	.215	.225	5.46	5.72	
Y	.290	.315	7.37	8.00	
Z	.514	.530	13.06	13.46	
AA	.089	.099	2.26	2.51	

Microsemi Catalog Number	Forward & Reverse Repetitive Blocking	Reverse Transient Blocking
Standard Lead		
08003GOA	300	400
08004GOA	400	500
08005GOA	500	600
08006GOA	600	700

To specify dv/dt higher than 200V/usec., contact factory.

- High dv/dt-200 V/usec.
- 1800 Amperes surge current
- Low forward on-state voltage
- Package conforming to either TO-209AC or TO-208AD outline
- Economical for general purpose phase control applications

Electrical Characteristics			
Max. RMS on-state current	I <sub>T(RMS)</sub> 125 Amps	T <sub>C</sub> = 87°C	
Max. average on-state cur.	I <sub>T(AV)</sub> 80 Amps	T <sub>C</sub> = 87°C	
Max. peak on-state voltage	V <sub>TM</sub> 1.4 Volts	I <sub>TM</sub> = 220 A(peak)	
Max. holding current	I <sub>H</sub> 200 mA		
Max. peak one cycle surge current	I <sub>TSM</sub> 1800 A	T <sub>C</sub> = 87°C, 60 Hz	
Max. I <sup>2</sup> t capability for fusing	I <sup>2</sup> t 13,500A <sup>2</sup> S	t = 8.3 ms	

Thermal and Mechanical Characteristics		
Operating junction temp range	T <sub>J</sub>	-65°C to 125°C
Storage temperature range	T <sub>STG</sub>	-65°C to 150°C
Maximum thermal resistance	R <sub>ΘJC</sub>	0.40°C/W Junction to case
Typical thermal resistance (greased)	R <sub>ΘCS</sub>	0.20°C/W Case to sink
Mounting torque		100-130 inch pounds
Weight		080-GOA Approx. 3.6 ounces (102.0 grams) typical
		080-GOD Approx. 3.24 ounces (91.8 grams) typical



080

Switching

Critical rate of rise of on-state current (note 1)	di/dt	100A/usec.	T <sub>J</sub> = 125°C
Typical delay time (note 1)	t <sub>d</sub>	3.0 usec.	
Typical circuit commuted turn-off time (note 2)	t <sub>q</sub>	100 usec.	T <sub>J</sub> = 125°C

Note 1: I<sub>TM</sub> = 50A, V<sub>D</sub> = V<sub>DRM</sub>, V<sub>GT</sub> = 12V open circuit, 20 ohm-0.1 usec. rise time  
Note 2: I<sub>TM</sub> = 50A, di/dt = 5A/usec., V<sub>R</sub> during turn-off interval = 50V min.,  
reapplied dv/dt = 20V/usec., linear to rated V<sub>DRM</sub>, V<sub>GT</sub> = 0V

Triggering

Max. gate voltage to trigger	V <sub>GT</sub>	3.0V	T <sub>J</sub> = 25°C
Max. nontriggering gate voltage	V <sub>GD</sub>	0.25V	T <sub>J</sub> = 125°C
Max. gate current to trigger	I <sub>GT</sub>	100mA	T <sub>J</sub> = 25°C
Max. peak gate power	P <sub>GM</sub>	15W	
Average gate power	P <sub>G(AV)</sub>	3.0W	t <sub>p</sub> = 10 usec.
Max. peak gate current	I <sub>GM</sub>	4.0A	
Max. peak gate voltage (forward)	V <sub>GM</sub>	10V	
Max. peak gate voltage (reverse)	V <sub>GM</sub>	5.0V	

Blocking

Max. leakage current	I <sub>DRM</sub>	10mA	T <sub>J</sub> = 125°C & V <sub>DRM</sub>
Max. reverse leakage	I <sub>RRM</sub>	10mA	T <sub>J</sub> = 125°C & V <sub>RRM</sub>
Critical rate of rise of off-state voltage	dv/dt	200V/usec.	T <sub>J</sub> = 125°C

Figure 1  
Typical Forward On-State Characteristics

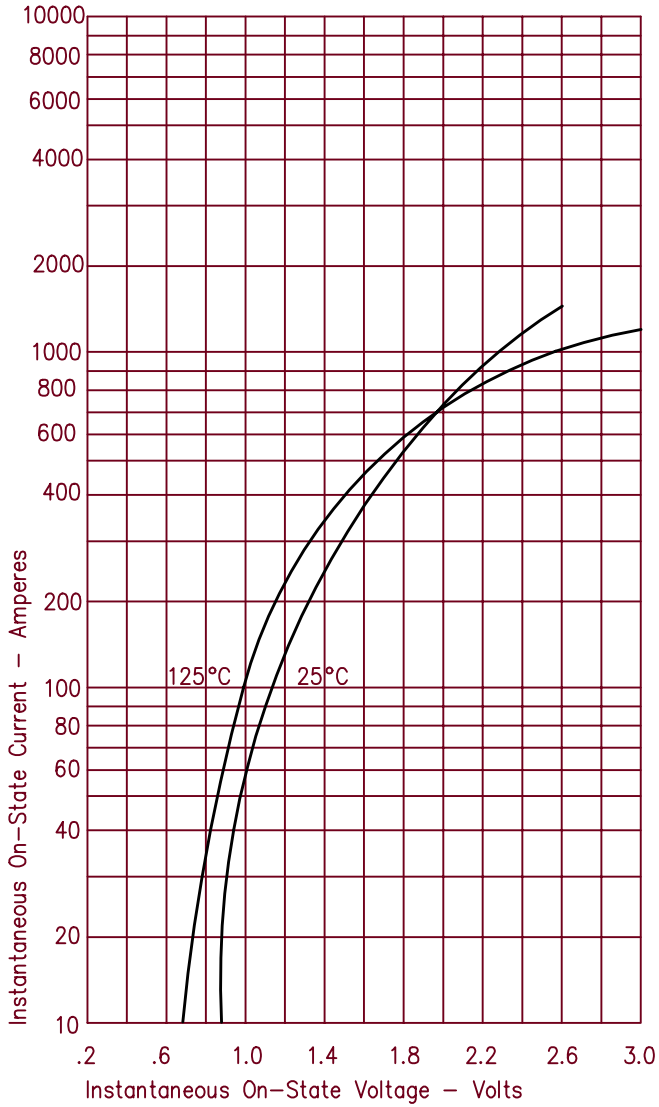


Figure 3  
Maximum Power Dissipation

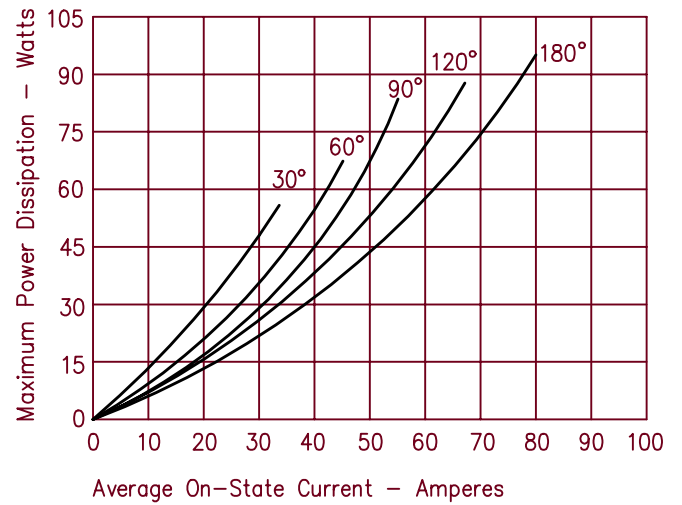


Figure 4  
Transient Thermal Impedance

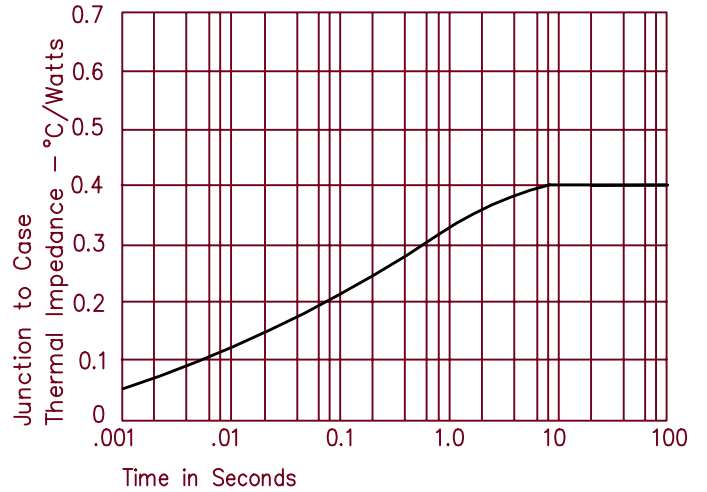


Figure 2  
Forward Current Derating

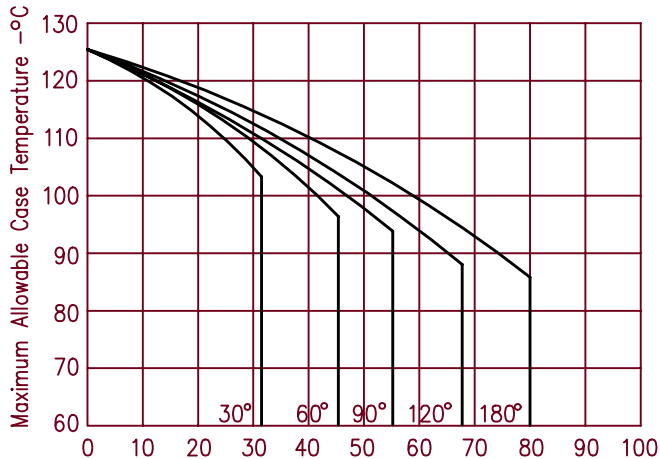


Figure 5  
Maximum Nonrepetitive Surge Current

